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У роботі запропонований багатопараметровий вимірювальний перетворювач на основі рухомого MEMS-елемента з електростатичним керуванням із стрибкоподібним збудженням. Отримані характеристики перетворення двопараметрового вимірювального перетворювача у багатомірному базисі, шляхом введення в коливальний рух рухомих MEMS – елементів за їх стрибкоподібного збудження перепадами напруги. На основі запропонованого підходу розглянуто особливості проектування датчика, призначеного для вимірювання температури та тиску. Проведено моделювання вимірювального перетворювача в системі MATLAB та отримані його градувальні характеристики.

Ключові слова: MEMS - конденсатор, матричний рухомий електрод, електростатичне керування, двопараметровий вимірювальний перетворювач

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MULTI- PARAMETER MEASURING TRANSDUCER, BASED ON JUMP- LIKE EXCITATION OF MOVABLE MEMS – ELEMENT

Abstract – In this work, a multi-parameter measuring transducer based on a movable MEMS-element with electrostatic control with jump - like excitation is proposed. Obtained characteristics of the transuding of a two-parameter measuring transducer in a multidimensional basis, by introducing into the oscillatory motion of movable MEMS-elements for their jump - like excitation by voltage transitions. Based on the proposed approach, the design of a sensor to measure temperature and pressure is constructed. Dynamic characteristics of the electrodes motion and simulate the signals at the output of the measuring transducer are obtained. The simulation of the measuring transducer in the MATLAB system was carried out and its calibration characteristics were obtained. The proposed measuring transducer has low power consumption, works at a low level of shock control voltage (0, 1 ... 0, 5) and in pulse mode. The two-parameter sensor is characterizing by high accuracy of measurements. The theoretically determined relative error of temperature measurement is 0, 95%, of the pressure - 0,05%.

Keywords: MEMS-capacitor, matrix movable electrode, electrostatic control, two-parameter measuring transducer

MEMS –

MEMS – [1-7].

MEMS –

[8-11].

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()

1.

MEMS –

$$i(t),$$

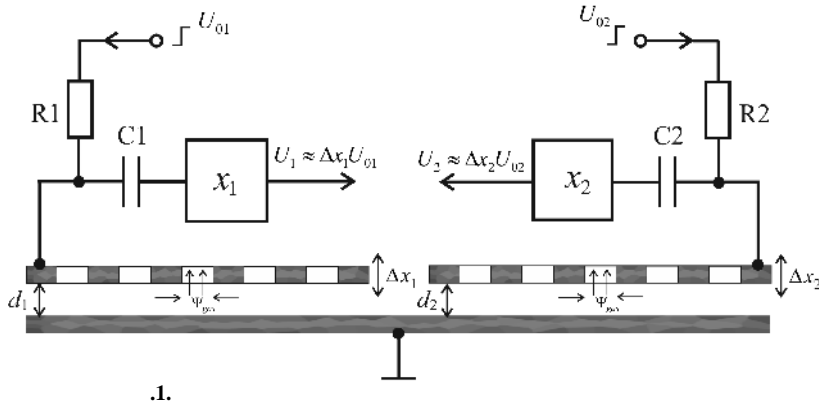
[10].

MEMS-

(),

$$\begin{pmatrix} \dots \\ \dots \end{pmatrix} \quad (1).$$

[12].



$$\theta(t), \quad a(t), \quad P(t), \quad A(t).$$

$$k_j, \quad b_j, \quad S_j, \quad m_j, \quad w_{0j}.$$

$$N, \quad N, \quad i(t) \quad [12]:$$

$$m_j \frac{d^2 x_j}{dt^2} + b_j \frac{dx_j}{dt} + k_j x_j = \frac{\varepsilon \varepsilon_0 S_j}{2} \left(\frac{U_{0j}}{d_j - x_j} \right)^2 + \sum_{i=1}^{N-1} f\{x_i(t)\}, \quad j = \overline{1, N}, \quad (1)$$

$$x_j - j - U_{0j} -$$

$$w_{0j}.$$

$$U_j(f\{x_i(t)\}, t) = g(x_j, t) \Rightarrow x_j(t) = f\{U_j(t)\}. \quad (2)$$

$$\frac{d^2 x_j}{dt^2} = \frac{d^2}{dt^2} f\{U_j(t)\}; \quad \frac{dx_j}{dt} = \frac{d}{dt} f\{U_j(t)\}. \quad (3)$$

$$(1) \quad (2, 3), \quad i(t).$$

$$\theta(t) \quad P(t). \quad (1)$$

$$m_1 \frac{d^2 x_1}{dt^2} + b_1 \frac{dx_1}{dt} + k_1 x_1 = \frac{\varepsilon \varepsilon_0 S_1}{2} \left(\frac{U_{01}}{d_1 - x_1} \right)^2 + \Delta P(t) S_1 - \left[\left(\frac{\alpha_{11} \delta_{11}}{C_{p11}} + \frac{\alpha_{12} \delta_{12}}{C_{p12}} \right) T_0 k_1 x_1 - \theta \right] \frac{k_1}{R_{T1}} \left(\frac{\alpha_{11} \delta_{11}}{C_{p11}} + \frac{\alpha_{12} \delta_{12}}{C_{p12}} \right) \quad (4)$$

$$m_2 \frac{d^2 x_2}{dt^2} + b_2 \frac{dx_2}{dt} + k_2 x_2 = \frac{\varepsilon \varepsilon_0 S_2}{2} \left(\frac{U_{02}}{d_2 - x_2} \right)^2 + \Delta P(t) S_2 - \left[\left(\frac{\alpha_{21} \delta_{21}}{C_{p21}} + \frac{\alpha_{22} \delta_{22}}{C_{p22}} \right) T_0 k_2 x_2 - \theta \right] \frac{k_2}{R_{T2}} \left(\frac{\alpha_{21} \delta_{21}}{C_{p21}} + \frac{\alpha_{22} \delta_{22}}{C_{p22}} \right)$$

$$\delta_{j1}, \delta_{j2} - j -$$

, $U, P; \alpha_{j1}, \alpha_{j2}$ -
 R_{Tj} - j - T_0 -
 θ - ΔP -
 b_j -
 b_s -
 b_{gas} :
 $b_j = b_s + b_{gas}$, (5)

b_s [13]:
 $b_s(T) = \frac{U_{0j}}{2} \left[\frac{1}{(d_j - x_j)p} - \frac{\epsilon \epsilon_0 S_j}{(d_j - x)^2 T_0 R_{Tj}} \right], p = \frac{d}{dt}$; (6)

b_{gas} (6) :
 $b_{gas} = b_m(L_e, W_e) + b_n(S, S, N)$, (7)

$b_m(L_e, W_e) = \eta(L_e - 0,6W_e) \times W_e^3$; $b_n(S, S, N) = \frac{12\eta S^2}{N \pi} \left(\frac{S}{2S} - \frac{S^2}{2S^2} - \frac{1}{4} \ln \left(\frac{S}{S} \right) - \frac{3}{8} \right)$

$W_e = S_e/L_e$; $L_e = (C_e + \sqrt{C_e^2 - 16S_e})/4$; $S = S - S_{sp} - \pi r^2(N_1 + N_2 - 1)$; $N = (N_1 - 1)(N_2 - 1)$;
 $S = \pi r^2$; $S_{sp} = N p^2$; $C_e = 2(L_1 + (N_1 - 1/2)\pi r) + 2(L_2 + (N_2 - 1/2)\pi r)$, r -
 N_1, N_2 , -

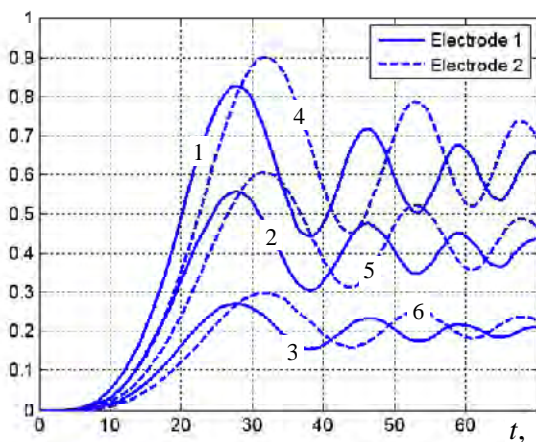
L_1, L_2 , p - S -
 $\eta = \frac{\eta_0}{1 + 9,638K_n^{1,159}}$, $K_n = \frac{P \times \lambda}{P_0 \times d}$, λ -
 (4)

.2, [14].

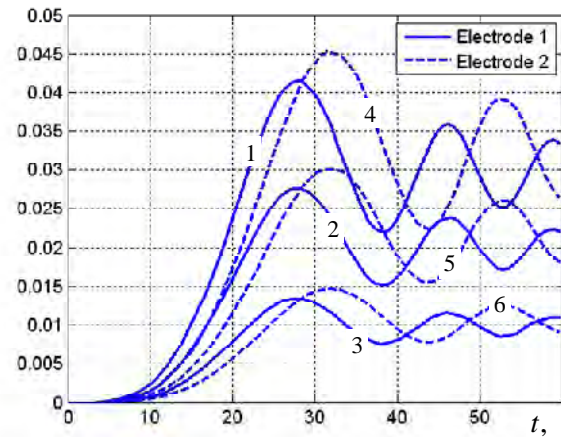
U_{0j} , θ , P .
 U_{0j}
 θ , ΔP ,

[15].

$x_j(t, \theta_i, \Delta P_i)$,



$U_j(t, \theta_i, \Delta P_i)$,



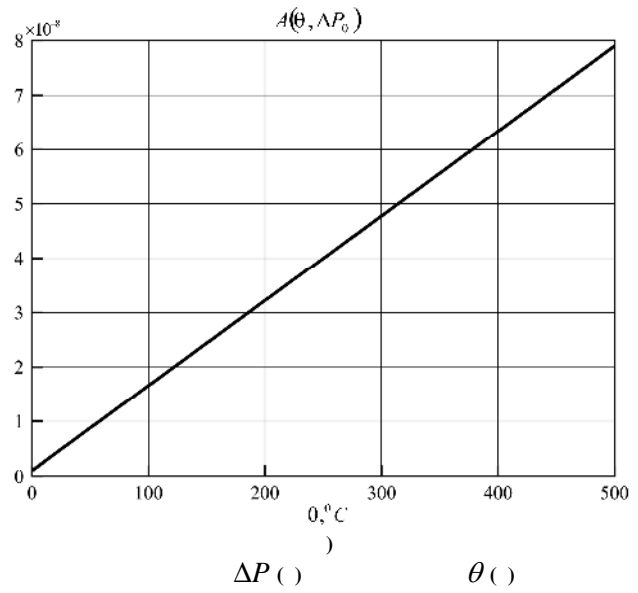
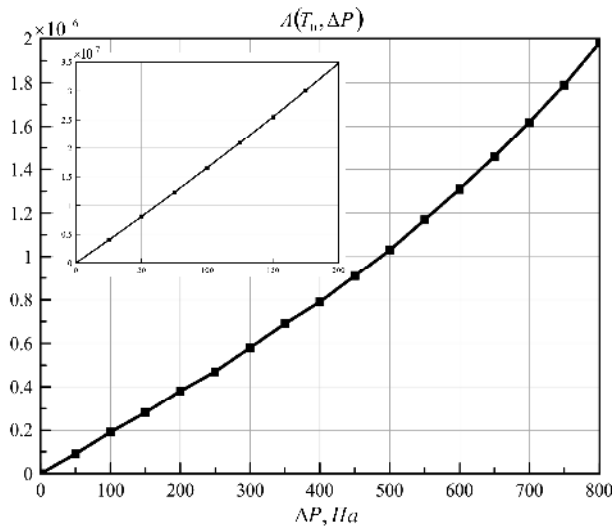
2-
 x_j j - () U_j () $\Delta P = 1500$, $\theta = 200$ (1,4);
 $\Delta P = 1000$, $\theta = 200$ (2,5); $\Delta P = 500$, $\theta = 100$ (3,6)

.3, ,

P $T_0 = const$

T

$P_0 = const.$



.3.

(.3, ,)

$\Delta P \in [0; 200]$

(.3,)
 P T

(4)

[16]:

$$\Delta P_i S_1 + \theta_i \frac{k_1}{R_{T1}} \left(\frac{\alpha_{11} \delta_{11}}{C_{p11}} + \frac{\alpha_{12} \delta_{12}}{C_{p12}} \right) = k_1 \frac{A_i(\theta_i, \Delta P_i)}{G_1} - \frac{\varepsilon \varepsilon_0 S_1}{2} \left(\frac{U_{01}}{d_1 - \frac{A_i(\theta_i, \Delta P_i)}{G_1}} \right)^2 ; \quad (9)$$

$$+ \left(\frac{\alpha_{11} \delta_{11}}{C_{p11}} + \frac{\alpha_{12} \delta_{12}}{C_{p12}} \right)^2 \frac{k_1^2}{R_{T1}} T_0 \frac{A_i(\theta_i, \Delta P_i)}{G_1}$$

$$\Delta P_i S_2 + \theta_i \frac{k_2}{R_{T2}} \left(\frac{\alpha_{21} \delta_{21}}{C_{p21}} + \frac{\alpha_{22} \delta_{22}}{C_{p22}} \right) = k_2 \frac{A_{2i}(\theta_i, \Delta P_i)}{G_2} - \frac{\varepsilon \varepsilon_0 S_2}{2} \left(\frac{U_{02}}{d_2 - \frac{A_{2i}(\theta_i, \Delta P_i)}{G_2}} \right)^2 +$$

$$+ \left(\frac{\alpha_{21} \delta_{21}}{C_{p21}} + \frac{\alpha_{22} \delta_{22}}{C_{p22}} \right)^2 \frac{k_2^2}{R_{T2}} T_0 \frac{A_{2i}(\theta_i, \Delta P_i)}{G_2}$$

$G_1, G_2 -$, $i = 1, \overline{M} -$

.4 ,

(9)

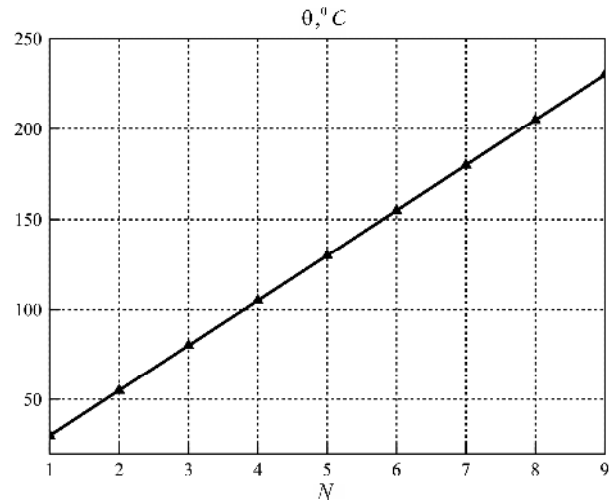
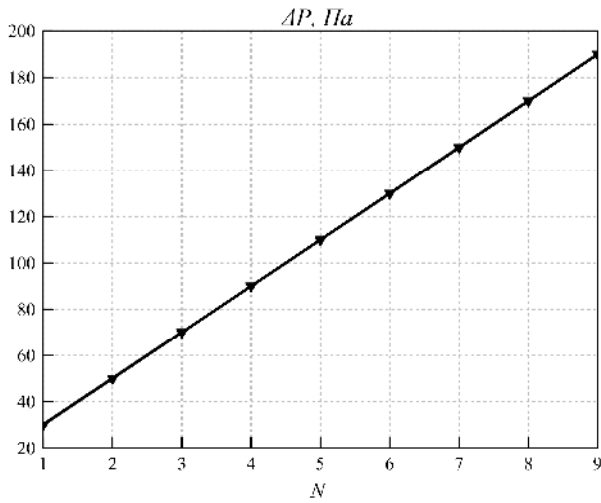
ΔP

$\theta -$

ΔP θ .

$\theta = (1...2)^\circ$

$\Delta P = (0,02...0,06)$,



4.

ΔP ()

θ ()

()

1.

(0,1...0,5)

2.

0,95%, -0,05%.

3.

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